

XP161A02A1PR



Power MOS FET

- ◆ N-Channel Power MOS FET
- ◆ DMOS Structure
- ◆ Low On-State Resistance: 0.11Ω (max)
- ◆ Ultra High-Speed Switching
- ◆ SOT-89 Package

Applications

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

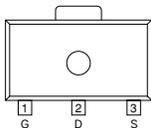
General Description

The XP161A02A1PR is an N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOT-89 package makes high density mounting possible.

Features

- Low on-state resistance** : $R_{ds(on)}=0.11\Omega(V_{gs}=4.5V)$
: $R_{ds(on)}=0.17\Omega(V_{gs}=2.5V)$
- Ultra high-speed switching**
- Operational Voltage** : 2.5V
- High density mounting** : SOT-89

Pin Configuration



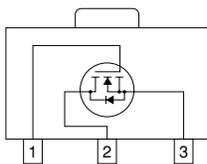
SOT-89
(TOP VIEW)

Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

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Equivalent Circuit



N-Channel MOS FET
(1 device built-in)

Absolute Maximum Ratings

$T_a=25^\circ\text{C}$

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	V_{dss}	20	V
Gate-Source Voltage	V_{gss}	± 12	V
Drain Current (DC)	I_d	3	A
Drain Current (Pulse)	I_{dp}	9	A
Reverse Drain Current	I_{dr}	3	A
Continuous Channel Power Dissipation (note)	P_d	2	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55-150	$^\circ\text{C}$

Note: When implemented on a ceramic PCB

Electrical Characteristics

DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds=20V, Vgs=0V			10	μA
Gate-Source Leakage Current	Igss	Vgs=±12V, Vds=0V			±10	μA
Gate-Source Cut-off Voltage	Vgs(off)	Id=1mA, Vds=10V	0.7			V
Drain-Source On-state Resistance (note)	Rds(on)	Id=1.5A, Vgs=4.5V		0.08	0.11	Ω
		Id=1.5A, Vgs=2.5V		0.13	0.17	Ω
Forward Transfer Admittance (note)	Yfs	Id=1.5A, Vds=10V		5		S
Body Drain Diode Forward Voltage	Vf	If=3A, Vgs=0V		0.85	1.1	V

Note: Effective during pulse test.

Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Input Capacitance	Ciss	Vds=10V, Vgs=0V f=1MHz		300		pF	
Output Capacitance	Coss				170		pF
Feedback Capacitance	Crss				60		pF

Switching Characteristics

Ta=25°C

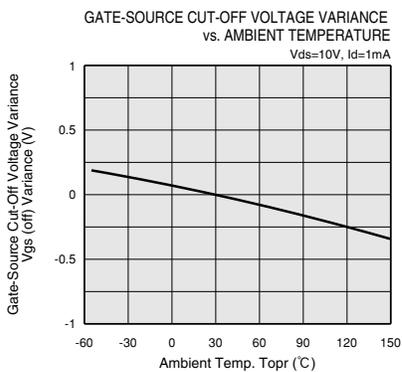
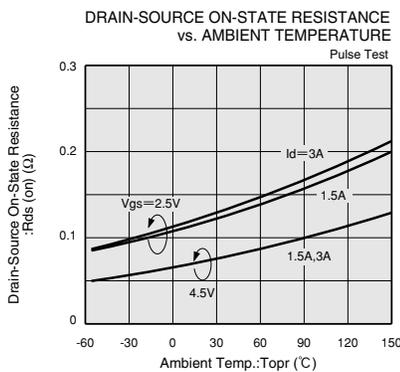
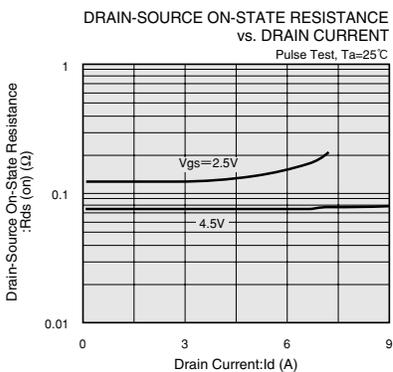
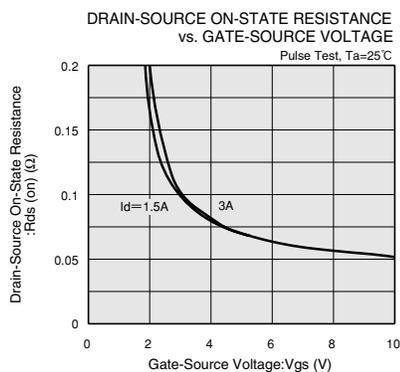
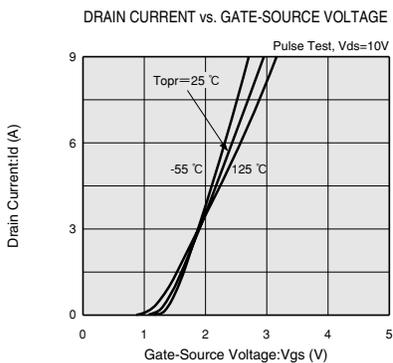
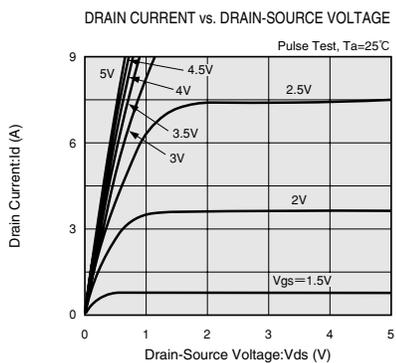
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td (on)	Vgs=5V, Id=1.5A Vdd=10V		10		ns
Rise Time	tr			15		ns
Turn-off Delay Time	td (off)			45		ns
Fall Time	tf			35		ns

Thermal Characteristics

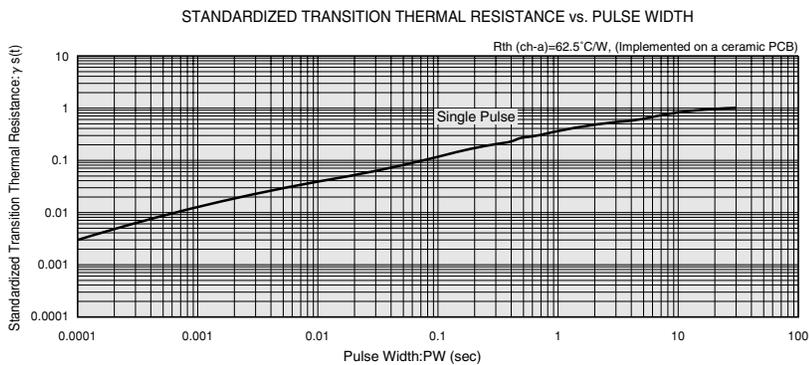
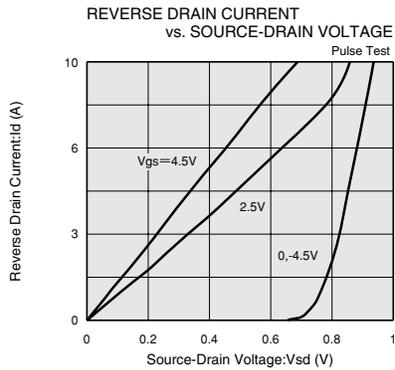
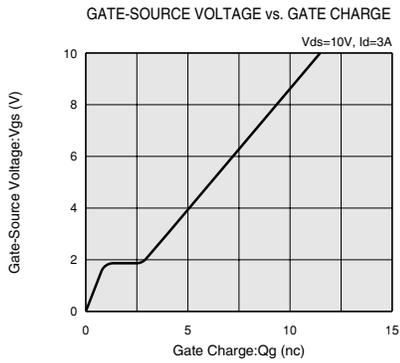
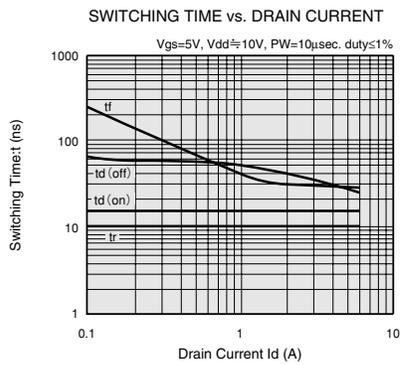
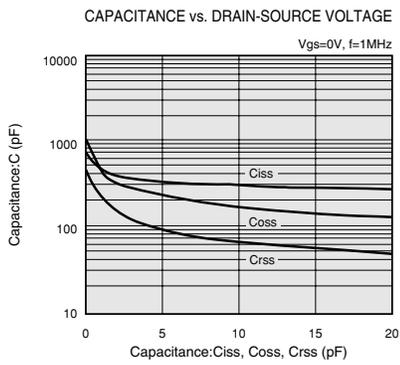
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance (channel-ambient)	Rth (ch-a)	Implement on a ceramic PCB		62.5		°C/W

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Typical Performance Characteristics



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